

Date: December 17, 2021





То,	To,	
The Manager	The Manager	
Listing Operations	Listing Department	
BSE Limited	National Stock Exchange of India Limited	
Sir Phiroze Jeejeebhoy Towers	Exchange Plaza,	
Dalal Street, Fort	Bandra Kurla Complex	
Mumbai - 400 001	Bandra (E), Mumbai-400051	
Scrip Code: 533080	Scrip Code: MOLDTKPAC-EQ	

Dear Madam/Sir(s),

Sub: Qualified institutions placement of of 14,00,000 equity shares of ₹5 each (the "Equity Share(s)") aggregating to ₹ 1036 million by Mold-Tek Packaging Limited (the "Company") (the "Issue") under the provisions of Chapter VI of Securities and Exchange Board of India (Issue of Capital and Disclosure Requirements) Regulations, 2018, as amended (the "SEBI ICDR Regulations").

Dear Sir/ Madam,

Please note that the Qualified Institutions Placement Committee ("QIP Committee") has, at its meeting held today i.e. December 17, 2021 approved the issue and allotment of 14,00,000 Equity Shares to the eligible qualified institutional buyers of the Issue at an Issue price of ₹740 per Equity Share (including a premium of ₹735 per Equity Share on face value of ₹5) which is at a premium of ₹17.60 per Equity Share i.e. 2.44% premium on the floor price of ₹722.40 per Equity Share, determined according to the formula prescribed under Regulation 176 of the SEBI ICDR Regulations. The Issue aggregated to ₹ 1,036 million.

The Issue opened on December 14, 2021 and closed on December 17, 2021 and the same was intimated to you through our letters dated December 14, 2021 and December 17, 2021 respectively.

Pursuant to the allotment of Equity Shares in the Issue, the paid-up equity share capital of the Company stands increased from ₹ 143774173.75, comprising of 28763585 Equity Shares to ₹ 150774173.75, comprising of 3,01,63,585 Equity Shares.

Further, find attached herewith the list of allottees who have been allotted more than five percent (5%) of the Equity Shares offered in the Issue, marked as **Annexure A**.

The meeting of the QIP Committee commenced at 8:30 p.m. and concluded at 9:00 p.m. A certified copy of the resolution passed by the Committee is enclosed for your information and records.

We request you to take the above on record and the same be treated as compliance under the applicable provisions of the Securities and Exchange Board of India (Listing Obligations and Disclosure Requirements) Regulations, 2015, as amended.

Thanking you,

Yours faithfully, For Mold-Tek Packaging Limited Thakur Vishal Singh Hyderabad Company Secretary

Corporate Office :

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ANNEXURE A

LIST OF ALLOTTEES WHO HAVE BEEN ALLOTTED MORE THAN 5% OF THE EQUITY SHARES OFFERED IN THE ISSUE

S No.	Name of the Allotee	No. of Shares Allotted	% of Issue Size
1	ICICI PRUDENTIAL SMALLCAP FUND	2,02,703	14.48
2	ASHOKA INDIA EQUITY INVESTMENT TRUST PLC	2,97,300	21.24
3	WHITE OAK INDIA EQUITY FUND IV	1,48,650	10.62
4	ADITYA BIRLA SUN LIFE TRUSTEE PRIVATE LIMITED A/C	2,70,270	19.30
4A	ADITYA BIRLA SUN LIFE MULTI-CAP FUND	1,35,135	9.65
4B	ADITYA BIRLA SUN LIFE BALANCED ADVANTAGE FUND	1,35,135	9.65
5	GOLDMAN SACHS FUNDS - GOLDMAN SACHS INDIA EQUITY PORTFOLIO	3,86,487	27.61

For Mold-Tek Packaging Limited

Thakur Vishal Singh Hyderabad **Company** Secretary